

Description

The CL9195 series are high ripple rejection, low power consumption, low dropout CMOS step-down voltage regulators with over-current and short circuit protection. These devices have very low quiescent bias current (60 μ A Typ.), they can deliver 500mA of output current with very small input and output voltage differences, and still maintain good regulation. Due to the small voltage difference between the input and output and the low quiescent bias current, these devices are especially suitable for battery-operated products such as computers, consumer products and industrial equipment, which want to prolong the useful battery life.

Feature

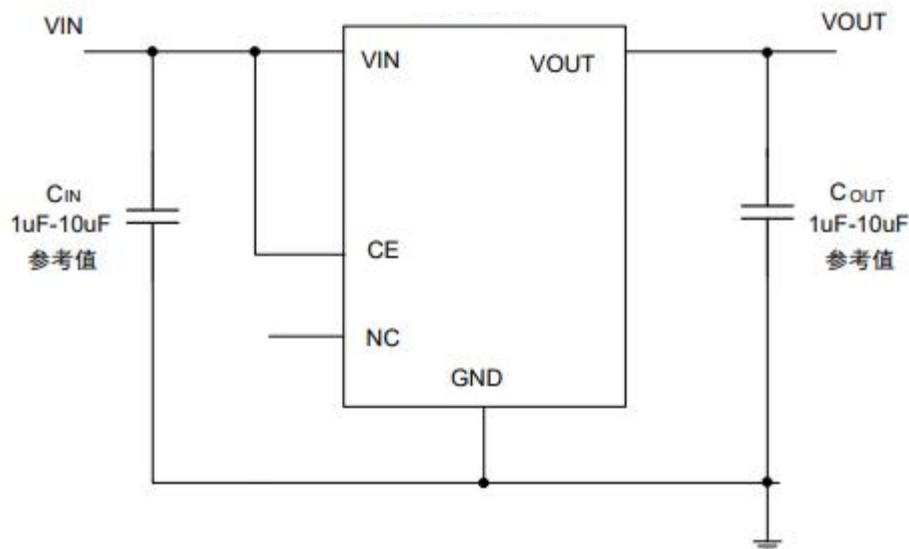
- ◆ Output Voltage Range: 1.2V-5.0V
- ◆ $I_o(\text{max})$: 500mA
- ◆ PSRR: 75dB/1KHz
- ◆ Stand-by Current : 60 μ A (Typ)
- ◆ Shunt-Down Current : 1 μ A (max)
- ◆ Operating Temperature Range : -40 °C ~ +85 °C

Applications

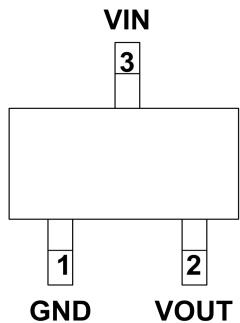
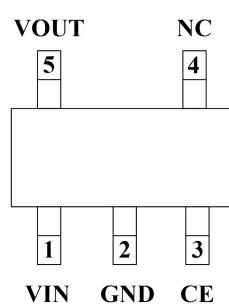
- ◆ CDMA / GSM
- ◆ PDAS/MP3
- ◆ WLAN/Bluetooth
- ◆ Portable Device
- ◆ Battery Power System

Package Type : SOT23-3L / SOT-23-5L

Application Circuit



Pin Description

SOT-23-3L

SOT-23-5L


| No SOT23-3L | No SOT23-5L | Name | Description |
|----------------|----------------|------|--------------|
| 3 | 1 | VIN | Power Supply |
| 1 | 2 | GND | Ground |
| | 3 | CE | Enable |
| | 4 | NC | No Connect |
| 2 | 5 | VOUT | Output |

Marking Information

| Part Number | Package Type | Marking |
|--------------|--------------|---------|
| CL9195A12L3M | SOT23-3L | HF=E** |
| CL9195A13L3M | SOT23-3L | ZU=E** |
| CL9195A15L3M | SOT23-3L | WG=J** |
| CL9195A18L3M | SOT23-3L | XB=N** |
| CL9195A25L3M | SOT23-3L | WH=U** |
| CL9195A27L3M | SOT23-3L | WK=F** |
| CL9195A28L3M | SOT23-3L | XD=U** |
| CL9195A29L3M | SOT23-3L | WN=C** |
| CL9195A30L3M | SOT23-3L | WW=P** |
| CL9195A33L3M | SOT23-3L | WA=E** |
| CL9195A12L5M | SOT23-5L | WE=F** |
| CL9195A13L5M | SOT23-5L | ZU=D** |
| CL9195A15L5M | SOT23-5L | WG=H** |
| CL9195A18L5M | SOT23-5L | XB=L** |
| CL9195A25L5M | SOT23-5L | WH=M** |
| CL9195A27L5M | SOT23-5L | WK=E** |
| CL9195A28L5M | SOT23-5L | XD=R** |
| CL9195A29L5M | SOT23-5L | WN=B** |
| CL9195A30L5M | SOT23-5L | WW=S** |
| CL9195A33L5M | SOT23-5L | WJ=K** |
| CL9195A36L5M | SOT23-5L | WA=C** |

Absolute Maximum Ratings

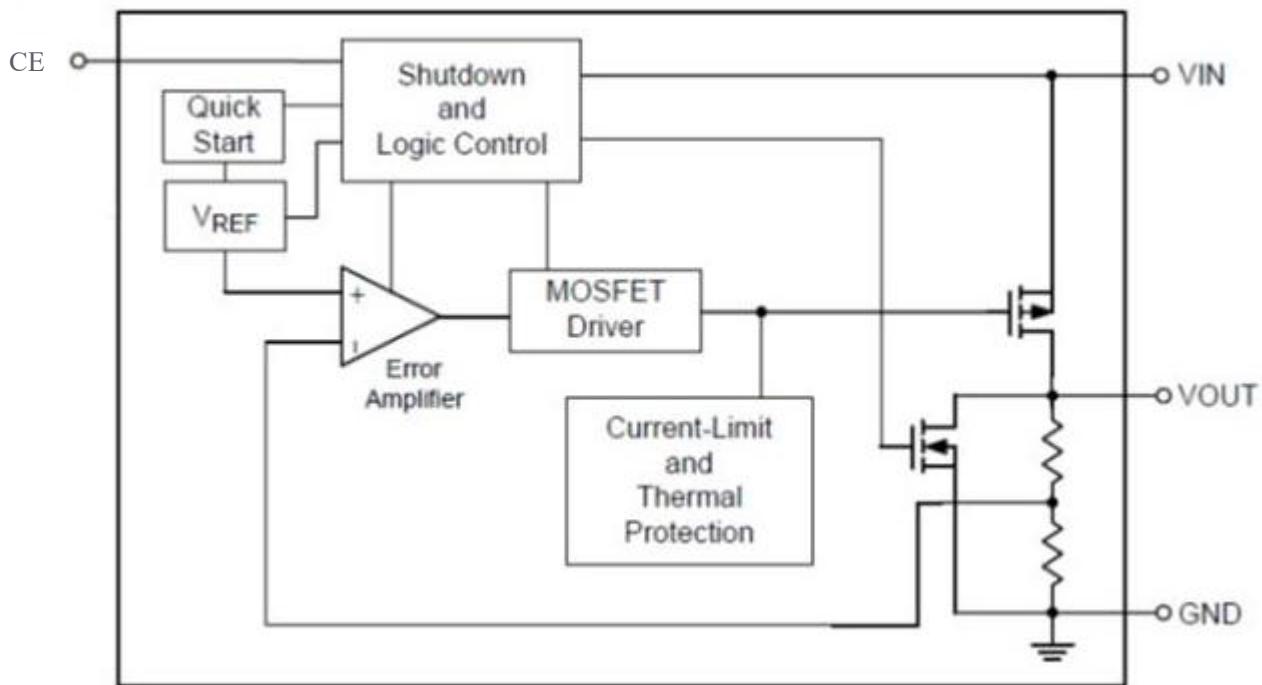
| Parameter | Symbol | Rating | Unit |
|----------------|---------------------|--|------|
| Input Voltage | V _{IN} | 7 | V |
| Output Current | I _{out} | 600 | mA |
| Output Voltage | V _{out} | V _{ss} -0.3 ~ V _{out} +0.3 | V |
| Operating Temp | T _{Opr} | -40 ~ +85 | °C |
| Storage Temp | T _{stg} | -55 ~ +125 | °C |
| Lead Temp | T _{solder} | 260°C, 10s | °C |

Note : Exceeding the " Absolute Maximum Ratings " may damage the device. The device will operate within the recommended operating range, but its characteristics are not guaranteed. Exposure to absolute extreme parameter conditions for extended periods of time may affect device reliability.

Power Dissipation

| Package Type | Pd(mW) |
|--------------|--------|
| SOT-23-5L | 300 |
| SOT-23-3L | 250 |

Block Diagram



Electrical Characteristics

($V_{IN}=5V$, $T_A = 25^{\circ}C$ T unless otherwise specified)

| Parameter | Symbol | Conditions | Min. | Typ. | Max. | Unit |
|-------------------------------|--|---|--------|--------------------------|--------|-------|
| Output Voltage | $V_{OUT}(E)$ (Note 2) | $I_{OUT}=40mA$, $V_{IN}=V_{out}+1V$ | X 0.98 | $V_{OUT}(T)$ (Note 1) | X 1.02 | V |
| Input Voltage | V_{IN} | | | | 5.5 | V |
| Maximum Output Current | $I_{OUT(max)}$ | $V_{IN}=V_{out}+1V$ | | 500 | | mA |
| EN starting voltage | V_{CE_ON} (Note 3) | | 1.1 | | | V |
| EN off voltage | V_{CE_OFF} | | | | 0.4 | V |
| Load Regulation | ΔV_{OUT} | $V_{IN}=V_{out}+1V$, $1mA \leq I_{OUT} \leq 100mA$ | | 50 | | mV |
| Dropout Voltage (Note 3) | V_{dif1} | $I_{OUT} = 100mA$ | | 100 | | mV |
| | V_{dif2} | $I_{OUT} = 200mA$ | | 300 | | mV |
| Stand-by Current | I_{SS} | $V_{IN}=V_{out}+1V$ | | 60 | | μA |
| Shunt-down Current | I_{CEL} | $V_{ce}=0V$ | | 1 | | μA |
| Line Regulation | $\frac{\Delta V_{OUT}}{\Delta V_{IN} \cdot V_{OUT}}$ | $I_{OUT} = 40mA$ $V_{out}+1V \leq V_{IN} \leq 8V$ | | 0.03 | | %/V |
| Output Noise Voltage | en | $I_{OUT} = 40mA$, 300Hz~50kHz | | 50 | | uVRMS |
| Power Supply Rejection Ration | PSRR | $V_{in} = [V_{out}+1]V$ +1Vp-pAC $I_{OUT} = 40mA, f=1kHz$ | | 75 | | dB |

Note: 1、 $V_{OUT}(T)$: Specified output voltage

2、 $V_{OUT}(E)$: Effective output voltage (that is, the output voltage when $V_{IN} = (V_{OUT}(T)+1.0V)$ when I_{OUT} remains at a certain value).

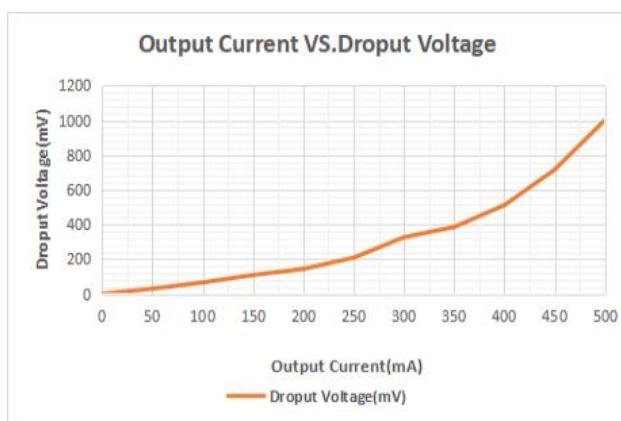
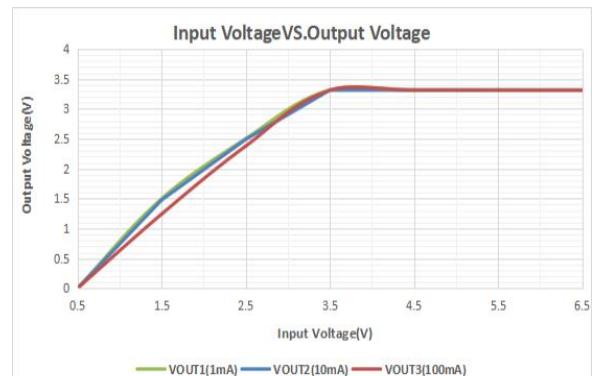
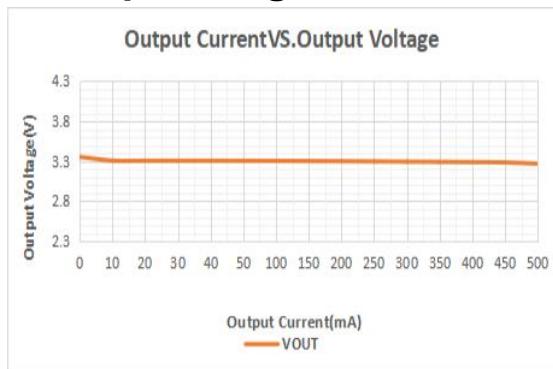
3、 V_{CE} : Considering the high and low temperature and process deviation, it is recommended that customers set the enable voltage of CE PIN to 1.1V with a margin.
There is a built-in $1M\Omega$ resistor between CE PIN and GND PIN inside the chip.

3、 V_{dif} : $V_{IN1} - V_{OUT}(E)'$

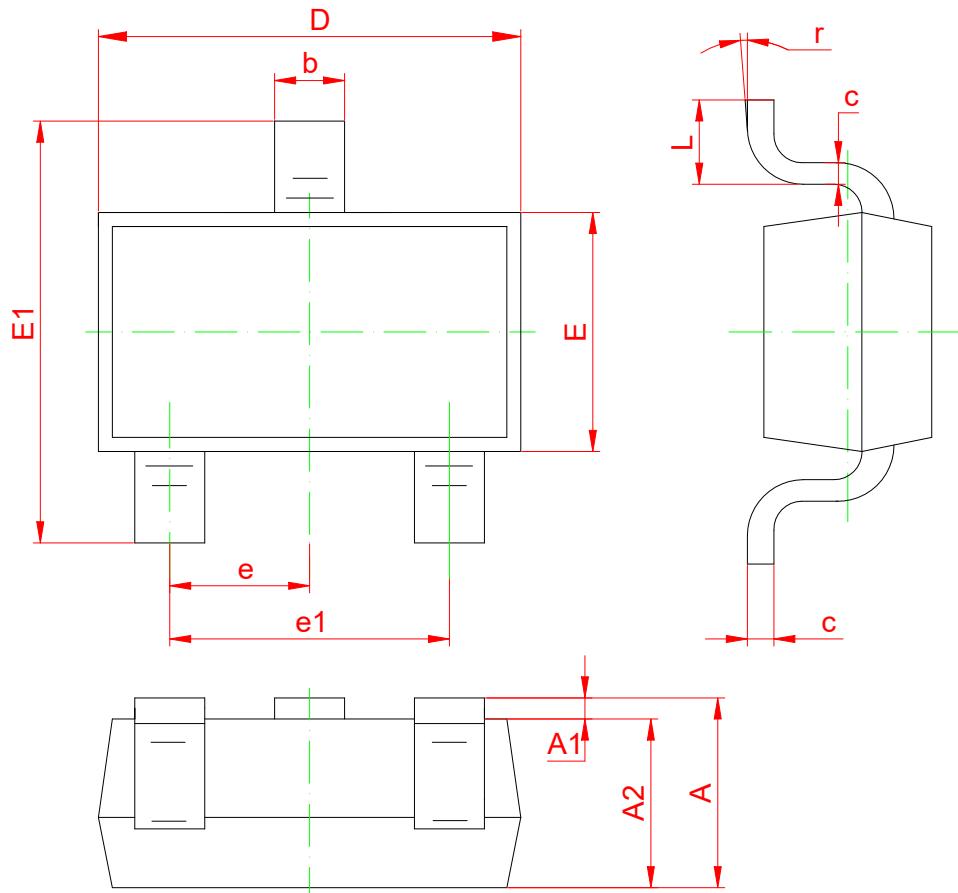
V_{IN1} : Gradually reduce the input voltage, the input voltage when the output voltage drops to 98% of $V_{OUT}(E)$.

$V_{OUT}(E)' = V_{OUT}(E) \times 98\%$.

Typical Operating Characteristics

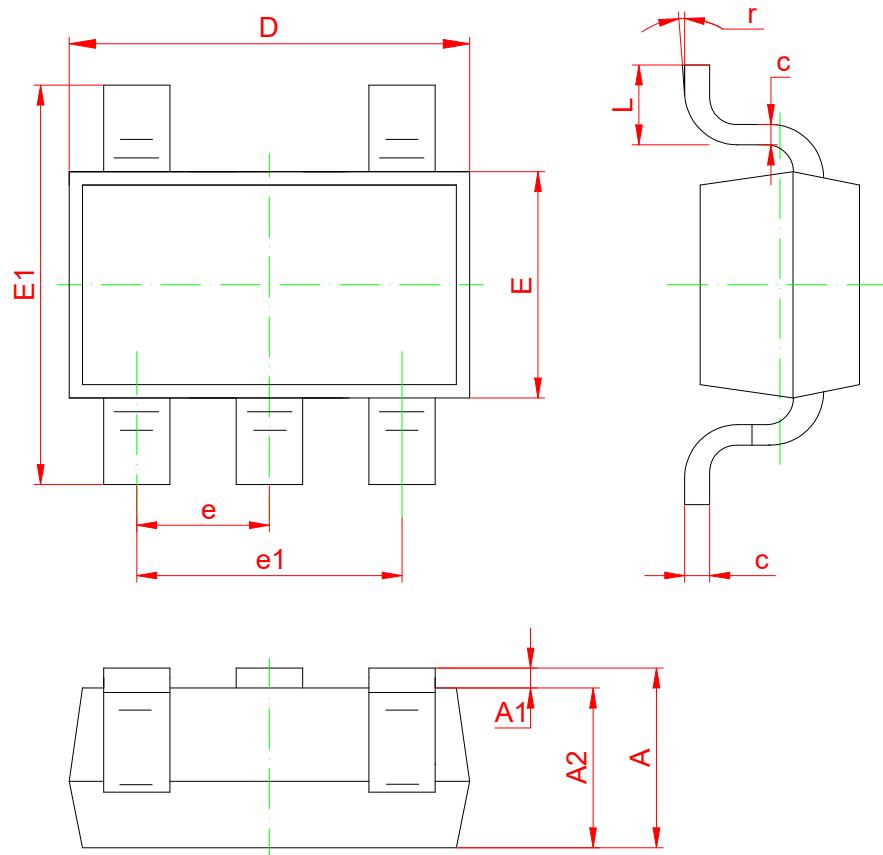


Output Current VS Dropout Voltage

Package Outline: SOT-23-3L


| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|--------|---------------------------|-------|----------------------|-------|
| | Min | Max | Min | Max |
| A | 1.050 | 1.250 | 0.041 | 0.049 |
| A1 | 0.000 | 0.100 | 0.000 | 0.004 |
| A2 | 1.050 | 1.150 | 0.041 | 0.045 |
| b | 0.300 | 0.500 | 0.012 | 0.020 |
| c | 0.100 | 0.200 | 0.004 | 0.008 |
| D | 2.820 | 3.020 | 0.111 | 0.119 |
| E | 1.500 | 1.700 | 0.059 | 0.067 |
| E1 | 2.650 | 2.950 | 0.104 | 0.116 |
| e | 0.950 (BSC) | | 0.037 (BSC) | |
| e1 | 1.800 | 2.000 | 0.071 | 0.079 |
| L | 0.300 | 0.600 | 0.012 | 0.024 |
| r | 0° | 8° | 0° | 8° |

Package Outline: SOT-23-5L



| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|--------|---------------------------|-------|----------------------|-------|
| | Min | Max | Min | Max |
| A | 1.050 | 1.250 | 0.041 | 0.049 |
| A1 | 0.000 | 0.100 | 0.000 | 0.004 |
| A2 | 1.050 | 1.150 | 0.041 | 0.045 |
| b | 0.300 | 0.500 | 0.012 | 0.020 |
| c | 0.100 | 0.200 | 0.004 | 0.008 |
| D | 2.820 | 3.020 | 0.111 | 0.119 |
| E | 1.500 | 1.700 | 0.059 | 0.067 |
| E1 | 2.650 | 2.950 | 0.104 | 0.116 |
| e | 0.950 (BSC) | | 0.037 (BSC) | |
| e1 | 1.800 | 2.000 | 0.071 | 0.079 |
| L | 0.300 | 0.600 | 0.012 | 0.024 |
| r | 0° | 8° | 0° | 8° |

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